

通信トランス

HDSL/HDSL2/SDSL/G.SHDSL

耐電圧 1500Vrms 動作温度 -40 ~ +85°C

UL1950第3版,UL60950,EN60950(適合状況につきましては個別仕様書をご参照ください)

総合歪率、リターンロス、挿入損失は、各社ICに最適設計されています



IC Manufacturer	IC Number	Part#	Application	Turns Ratio IC:Line	DCR Line max	DCR IC max	Inductance @10kHz0.1V (H) typ	Leakage Inductance (H) max	Mounting	Package Fig.	Schematic Fig.
Conexant	BT8970	TTC-4018	2320Kbps	1:2	2.09	0.94	1m	11 μ	THD	A	1
		TTC-4019	2320Kbps	1:2	2.09	1.05	1m	11 μ	SMD	B	1
	CN8980	TTC-4056	ALL	1:5	1.26	0.28	2m	0.5 μ	THD	A	1
	RS8973	TTC-4062	ALL	1:2	3.2	1.15	2m	6.5 μ	SMD	B	1
		TTC-4093	HDSL	1:2	3.2	1.15	2m	6.5 μ	THD	A	1
Globespan	G2237	TTC-4063	784Kbps	1:2.2	2.5	1.1	3m	10 μ	SMD	B	2
		TTC-4074	G.SHDSL	1:4	2.5	1	2m	11 μ	SMD	B	1
		TTC-4083	G.SHDSL	1:5.4	2.42	0.23	3m	12 μ	SMD	B	1
		TTC-4115	SHDSL,HDSL2 HDSL4	1:5.4	4.2	0.35	3m	15 μ	SMD	B	1
Infineon	PEB22622	TTC-4070	ALL	1:1.6	4.5	2.1	3m	33 μ	SMD	B	3
	PEB22622 PEF22623 PEF24622	TTC-4123	SHDSL	1:1.6	4.3	2	3m	25 μ	SMD	B	4
	SK70704 SK70707	TTC-4036	1168Kbps	1:1.8	7	3.17	0.6m	20 μ	SMD	B	1
Level One	SK70740 SK70741 SK70742	TTC-4084	HDSL2	1:2.3	3.72	0.9	2m	35 μ	SMD	B	5
		TTC-4089	HDSL	1:2	2.5	1.4	2m	10 μ	SMD	B	6

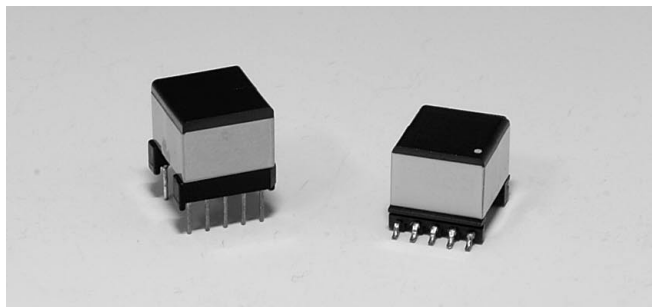
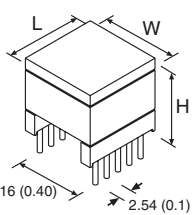
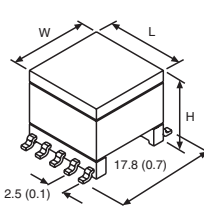


Fig.A



L: 14.0(0.55) W: 14.0(0.55) H: 13.5(0.53)

Fig.B



L: 14.0(0.55) W: 14.0(0.55) H: 12.7(0.50)

Fig.1

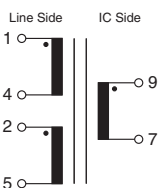


Fig.2

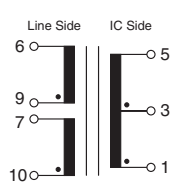


Fig.3

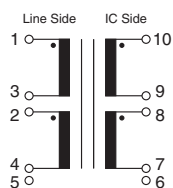


Fig.4

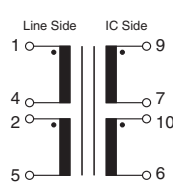


Fig.5

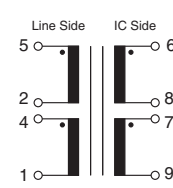


Fig.6

